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Document Number (Optional)

MEG-02-015

Application Number

10/685,872

Applicant

M.S. Lin

Filing Date

10/15/03

Oral Art Unit

U. S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILED DATE IF APPROPRIATE
7P	6 38 39 1 6	5/7/02	Lin	438	637	2/17/99
2P	6 49 54 42	12/17/02	Lin et al.	438	618	10/18/00
2P	6 30 34 23	10/16/01	Lin	438	238	11/27/00

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

2P	-	Multichip Module Technologies and Alternatives: the basics
		Copyright 1993 by Van Nostrand Reinhold pp. 755 and 757.
2P	-	MSL 98-002 CCC-CIP, serial number 10/154,662,
		Filed 5/24/02, "Top Layers of Metal for High Performance IC's".

EXAMINER

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